

# EDCON-COMPONENTS

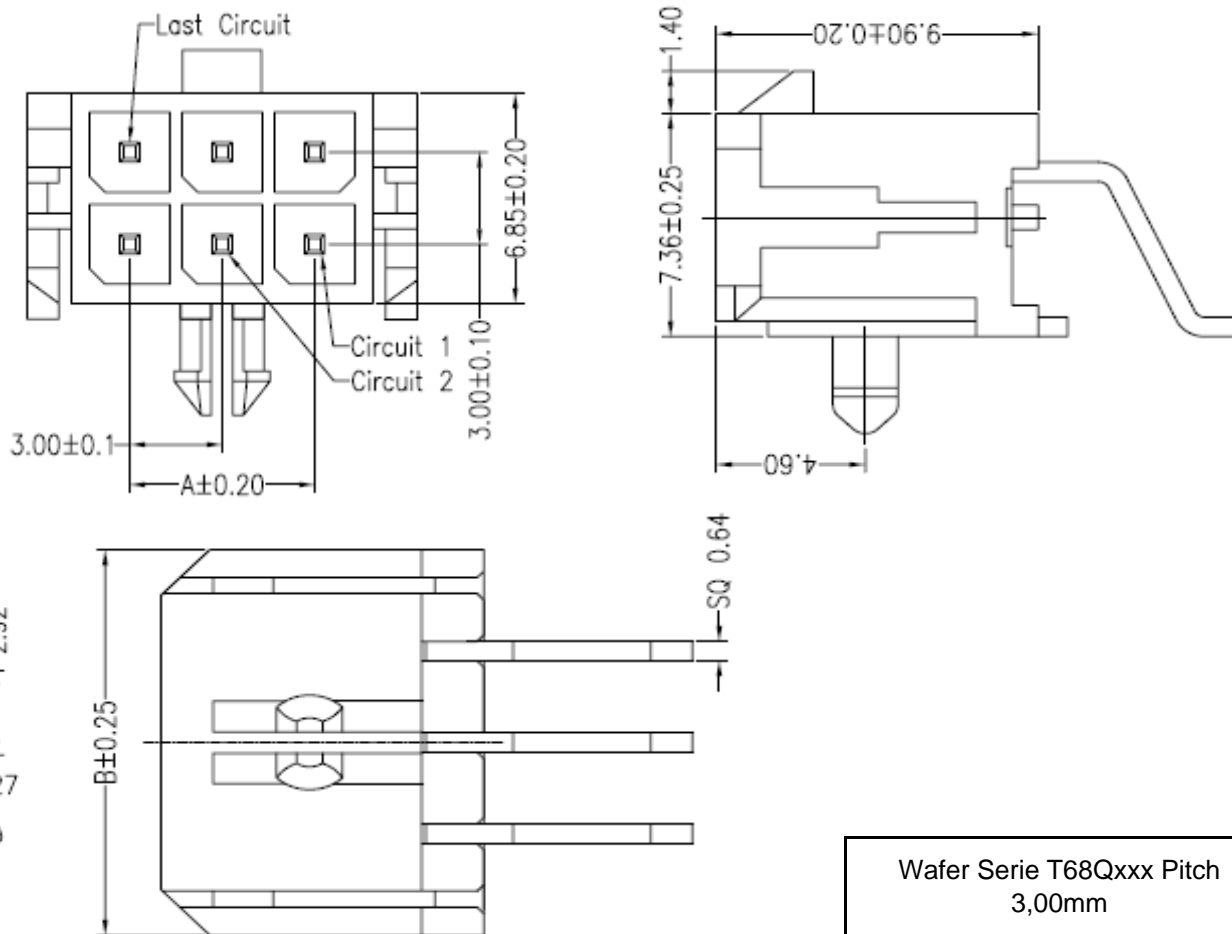


## Specifications

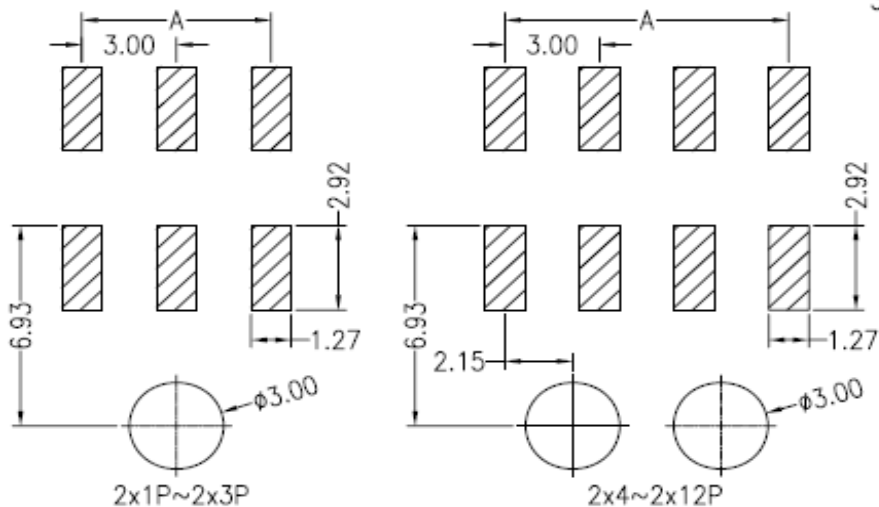
Voltage Rating: 250VAC/DC  
 Current Rating 5,0A  
 Operating Temperature  $-25^{\circ}\text{C} \sim +85^{\circ}\text{C}$   
 Contact Resistance 10m Ohm max.  
 Withstanding Voltage 1500VAC/Minute  
 Insulation Resistance 1000M Ohm min.

Contact Material: Brass  
 Contact Plating : AU or Sn over Ni.  
 Insulator Material: High Temperature Plastic  
 UL94V-0

## Drawing ( dimensions all into mm)



## Terminal Assembly Drawing



Wafer Serie T68Qxxx Pitch  
3,00mm

Part No.: **T68Q011**

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	02.04.2009
APPD:	Schumi			FINISH	Jamy		Sheet No.		1 from 4

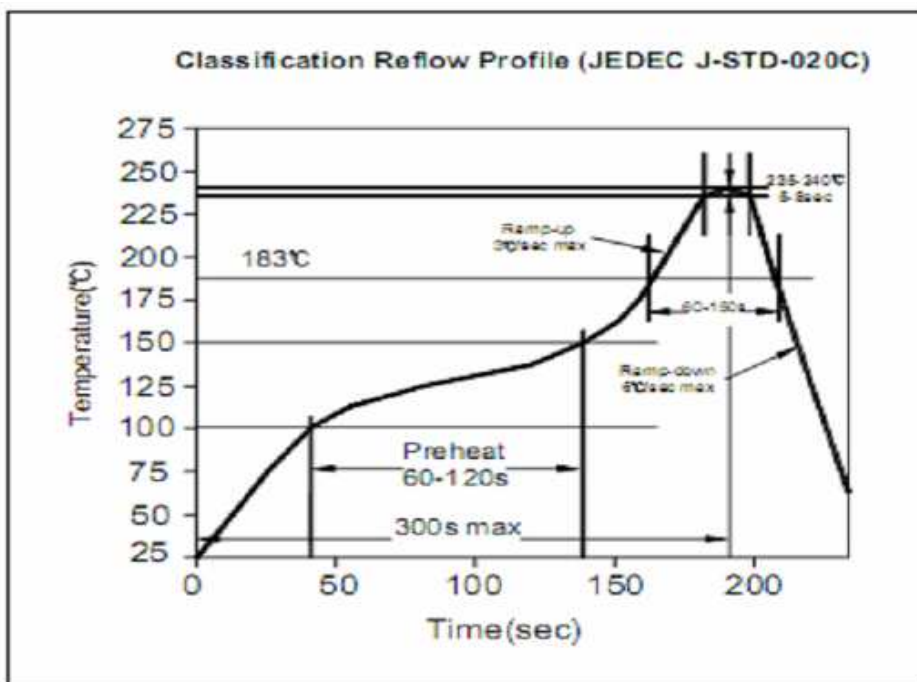
Customer:



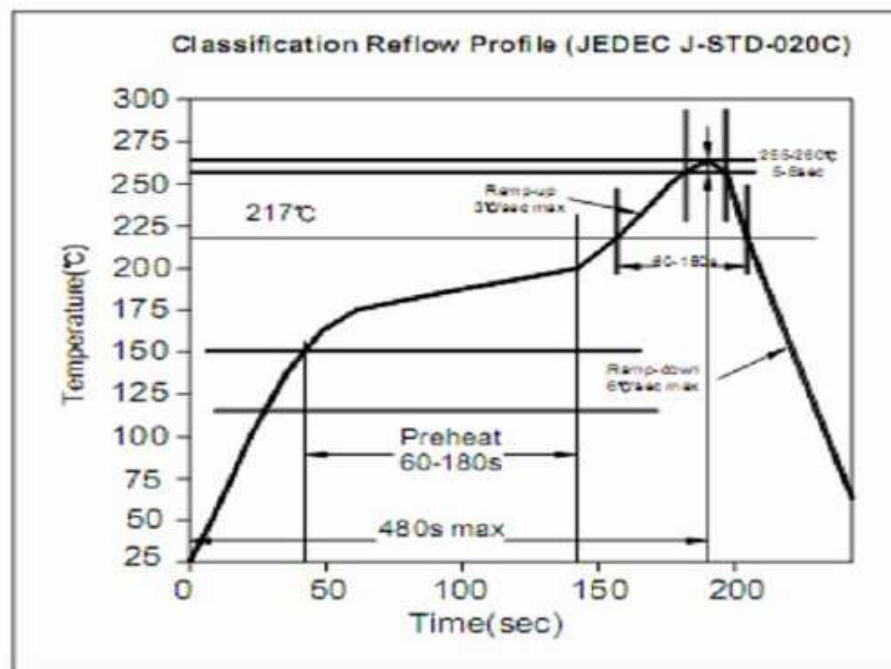


Soldering Profile

Lead Solder



Lead Free Solder



Wafer Serie T68Qxxx Pitch 3,00mm
Part No.: <b>T68Q011</b>
Customer:

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## Ordering Informations

Serie	Number of	Contact	Packing						
T68Q011	02	T	BU						

<b>xx = Pos.</b>	<b>T=</b> Tin Plated (Standard)	<b>BU=</b> Bulk (Standard)							
		<b>TY=</b> Tray Packing							
	<b>G=</b> Gold Flash Plated	<b>TU=</b> Tube Packing							

Wafer Serie T68Qxxx Pitch 3,00mm	
Part No.:	<b>T68Q011</b>
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[www.edcon-components.com](http://www.edcon-components.com)

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